

# TPC8208

Lithium Ion Battery Applications

Notebook PC Applications

Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance:  $R_{DS(ON)} = 38\text{ m}\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 6.3\text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 10\text{ }\mu\text{A}$  (max) ( $V_{DS} = 20\text{ V}$ )
- Enhancement mode:  $V_{th} = 0.5\text{ to }1.2\text{ V}$  ( $V_{DS} = 10\text{ V}$ ,  $I_D = 200\text{ }\mu\text{A}$ )

## Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

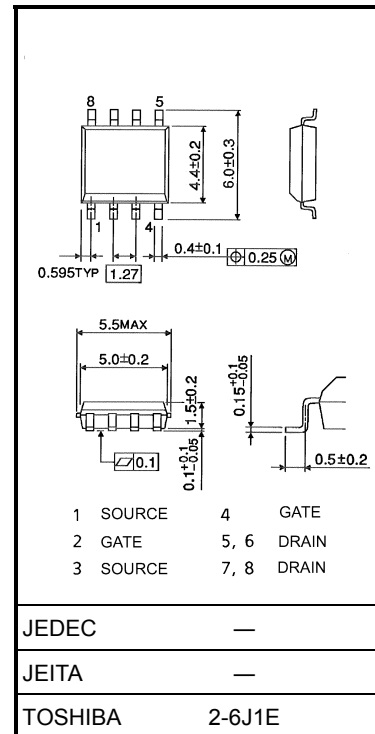
| Characteristics                                                                          |                                                 | Symbol    | Rating     | Unit             |
|------------------------------------------------------------------------------------------|-------------------------------------------------|-----------|------------|------------------|
| Drain-source voltage                                                                     |                                                 | $V_{DSS}$ | 20         | V                |
| Drain-gate voltage ( $R_{GS} = 20\text{ k}\Omega$ )                                      |                                                 | $V_{DGR}$ | 20         | V                |
| Gate-source voltage                                                                      |                                                 | $V_{GSS}$ | $\pm 12$   | V                |
| Drain current                                                                            | DC (Note 1)                                     | $I_D$     | 5          | A                |
|                                                                                          | Pulse (Note 1)                                  | $I_{DP}$  | 20         |                  |
| Drain power dissipation<br>( $t = 10\text{ s}$ )<br>(Note 2a)                            | Single-device operation (Note 3a)               | $P_D(1)$  | 1.5        | W                |
|                                                                                          | Single-device value at dual operation (Note 3b) | $P_D(2)$  | 1.1        |                  |
| Drain power dissipation<br>( $t = 10\text{ s}$ )<br>(Note 2b)                            | Single-device operation (Note 3a)               | $P_D(1)$  | 0.75       | W                |
|                                                                                          | Single-device value at dual operation (Note 3b) | $P_D(2)$  | 0.45       |                  |
| Single pulse avalanche energy (Note 4)                                                   |                                                 | $E_{AS}$  | 16.3       | mJ               |
| Avalanche current                                                                        |                                                 | $I_{AR}$  | 5          | A                |
| Repetitive avalanche energy<br>Single-device value at dual operation<br>(Note 2a, 3b, 5) |                                                 | $E_{AR}$  | 0.1        | mJ               |
| Channel temperature                                                                      |                                                 | $T_{ch}$  | 150        | $^\circ\text{C}$ |
| Storage temperature range                                                                |                                                 | $T_{stg}$ | -55 to 150 | $^\circ\text{C}$ |

Note: Note 1, Note 2, Note 3, Note 4 and Note 5: See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

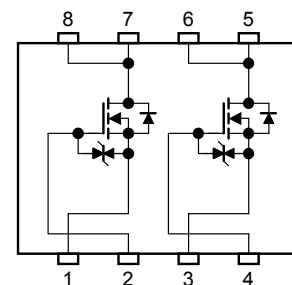
This transistor is an electrostatic-sensitive device. Please handle with caution.

Unit: mm



Weight: 0.080 g (typ.)

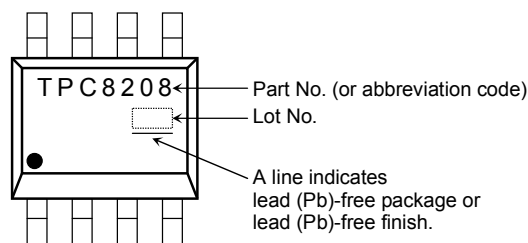
## Circuit Configuration



## Thermal Characteristics

| Characteristics                                                      |                                                       | Symbol            | Max  | Unit                 |
|----------------------------------------------------------------------|-------------------------------------------------------|-------------------|------|----------------------|
| Thermal resistance, channel to ambient<br>( $t = 10$ s)<br>(Note 2a) | Single-device operation<br>(Note 3a)                  | $R_{th(ch-a)}(1)$ | 83.3 | $^{\circ}\text{C/W}$ |
|                                                                      | Single-device value at<br>dual operation<br>(Note 3b) | $R_{th(ch-a)}(2)$ | 114  |                      |
| Thermal resistance, channel to ambient<br>( $t = 10$ s)<br>(Note 2b) | Single-device operation<br>(Note 3a)                  | $R_{th(ch-a)}(1)$ | 167  | $^{\circ}\text{C/W}$ |
|                                                                      | Single-device value at<br>dual operation<br>(Note 3b) | $R_{th(ch-a)}(2)$ | 278  |                      |

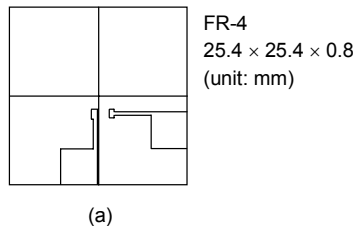
## Marking (Note 6)



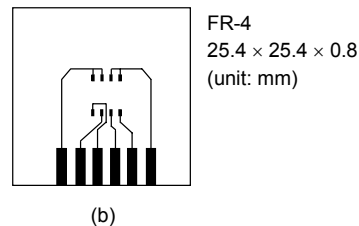
Note 1: Ensure that the channel temperature does not exceed  $150^{\circ}\text{C}$ .

Note 2:

a) Device mounted on a glass-epoxy board (a)



b) Device mounted on a glass-epoxy board (b)



Note 3:

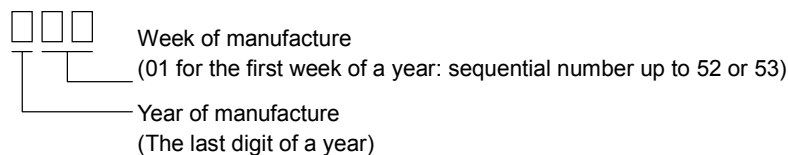
- The power dissipation and thermal resistance values are shown for a single device. (During single-device operation, power is only applied to one device.)
- The power dissipation and thermal resistance values are shown for a single device. (During dual operation, power is evenly applied to both devices.)

Note 4:  $V_{DD} = 16$  V,  $T_{ch} = 25^{\circ}\text{C}$  (initial),  $L = 0.5$  mH,  $R_G = 25$   $\Omega$ ,  $I_{AR} = 5$  A

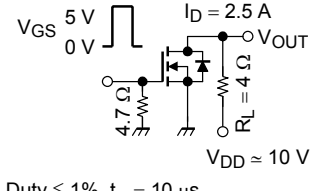
Note 5: Repetitive rating: pulse width limited by maximum channel temperature

Note 6: • on lower left of the marking indicates Pin 1.

※ Weekly code: (Three digits)

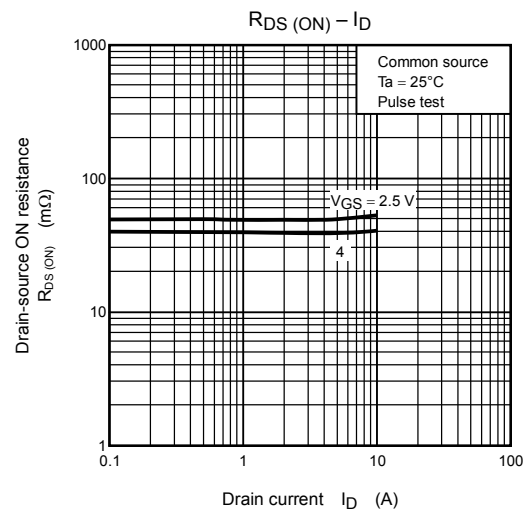
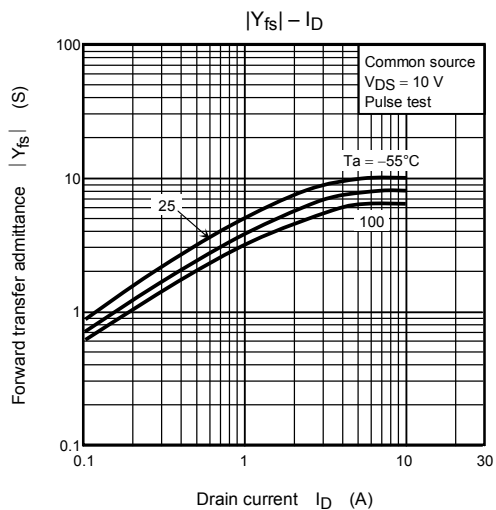
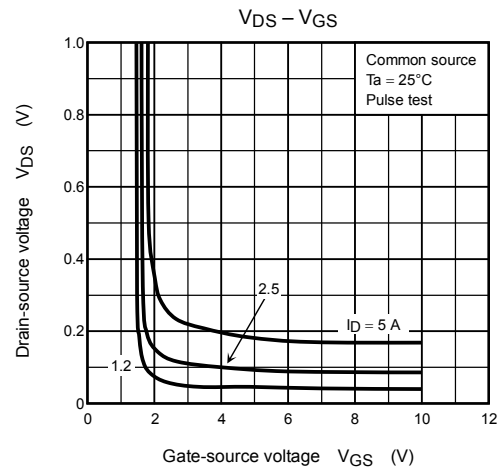
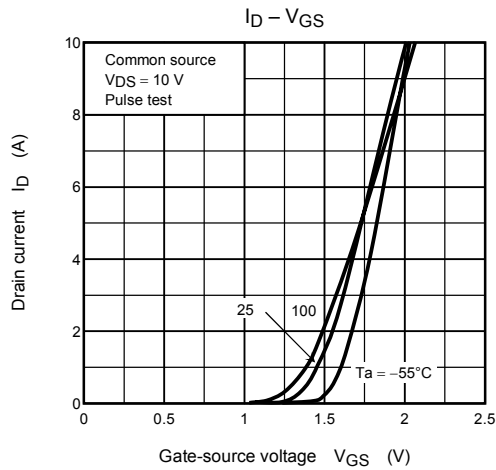
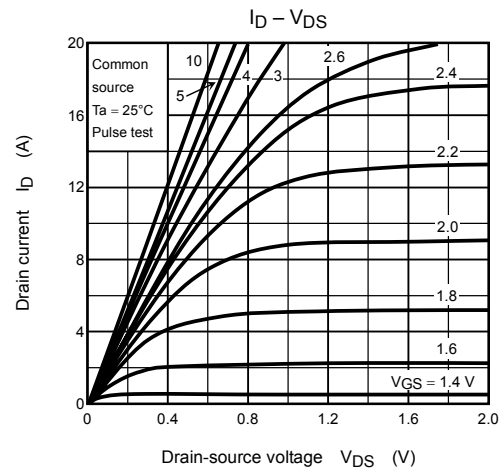
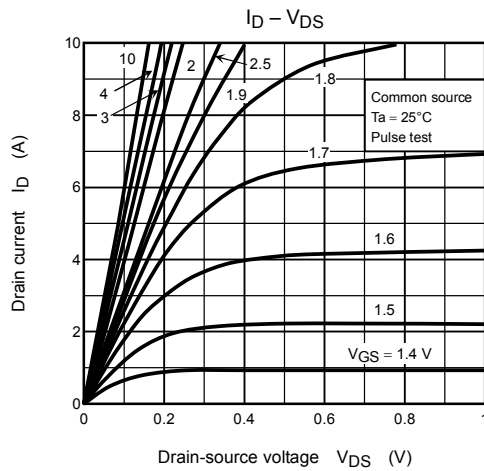


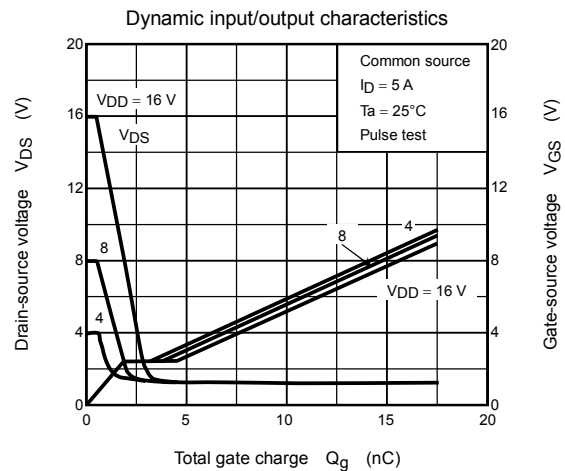
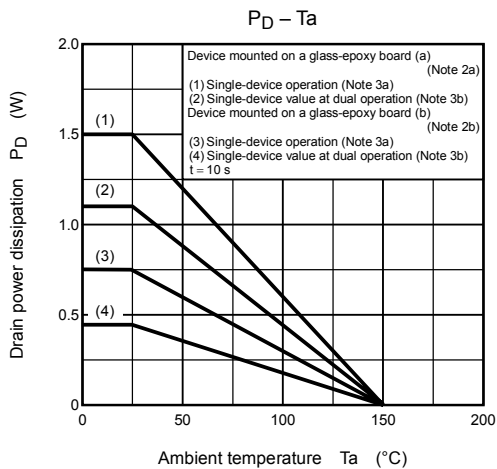
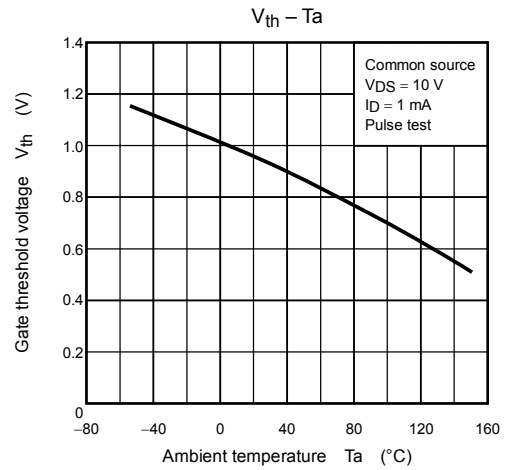
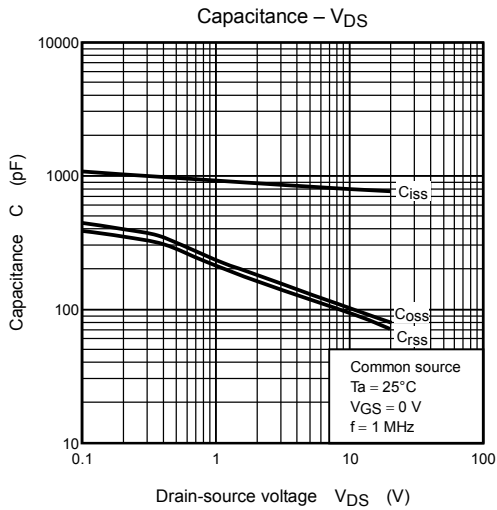
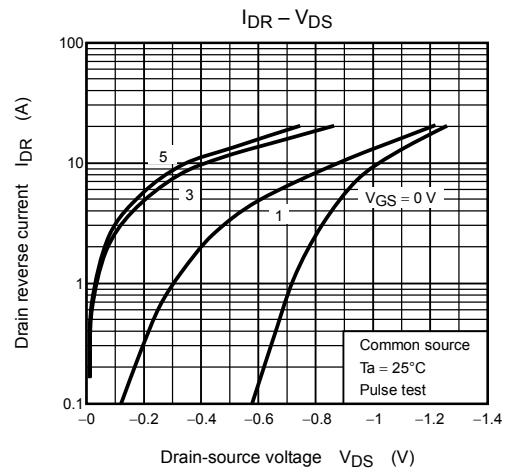
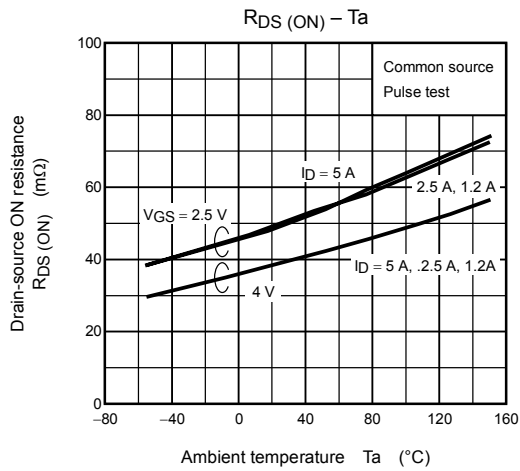
## Electrical Characteristics (Ta = 25°C)

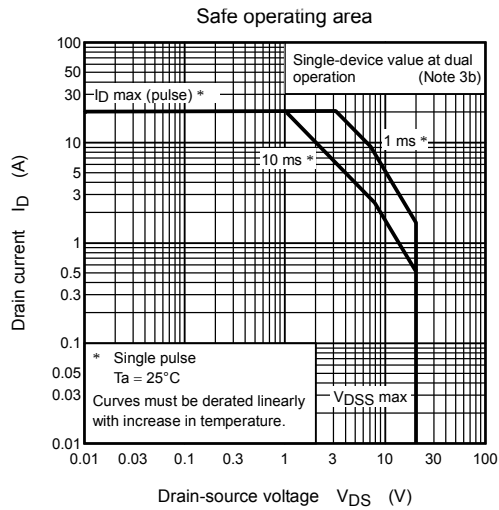
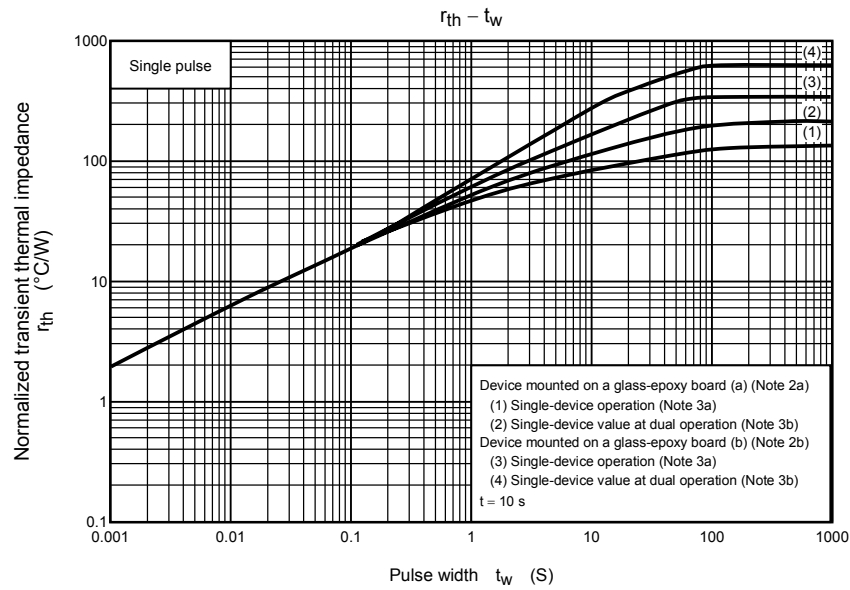
| Characteristics                                 |                | Symbol                                           | Test Condition                                                                                                                                                                                                                                                                                                                                                                                          | Min | Typ. | Max              | Unit          |
|-------------------------------------------------|----------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|------------------|---------------|
| Gate leakage current                            |                | $I_{GSS}$                                        | $V_{GS} = \pm 10 \text{ V}$ , $V_{DS} = 0 \text{ V}$                                                                                                                                                                                                                                                                                                                                                    | —   | —    | $\pm 10$         | $\mu\text{A}$ |
| Drain cut-OFF current                           |                | $I_{DSS}$                                        | $V_{DS} = 20 \text{ V}$ , $V_{GS} = 0 \text{ V}$                                                                                                                                                                                                                                                                                                                                                        | —   | —    | 10               | $\mu\text{A}$ |
| Drain-source breakdown voltage                  | $V_{(BR) DSS}$ | $I_D = 10 \text{ mA}$ , $V_{GS} = 0 \text{ V}$   | 20                                                                                                                                                                                                                                                                                                                                                                                                      | —   | —    | V                |               |
|                                                 | $V_{(BR) DSX}$ | $I_D = 10 \text{ mA}$ , $V_{GS} = -12 \text{ V}$ | 8                                                                                                                                                                                                                                                                                                                                                                                                       | —   | —    |                  |               |
| Gate threshold voltage                          |                | $V_{th}$                                         | $V_{DS} = 10 \text{ V}$ , $I_D = 200 \mu\text{A}$                                                                                                                                                                                                                                                                                                                                                       | 0.5 | —    | 1.2              | V             |
| Drain-source ON resistance                      | $R_{DS (ON)}$  | $V_{GS} = 2.0 \text{ V}$ , $I_D = 2.5 \text{ A}$ | —                                                                                                                                                                                                                                                                                                                                                                                                       | 57  | 100  | $\text{m}\Omega$ |               |
|                                                 |                | $V_{GS} = 2.5 \text{ V}$ , $I_D = 2.5 \text{ A}$ | —                                                                                                                                                                                                                                                                                                                                                                                                       | 46  | 70   |                  |               |
|                                                 |                | $V_{GS} = 4.0 \text{ V}$ , $I_D = 2.5 \text{ A}$ | —                                                                                                                                                                                                                                                                                                                                                                                                       | 38  | 50   |                  |               |
| Forward transfer admittance                     |                | $ Y_{fs} $                                       | $V_{DS} = 10 \text{ V}$ , $I_D = 2.5 \text{ A}$                                                                                                                                                                                                                                                                                                                                                         | 3.2 | 6.3  | —                | S             |
| Input capacitance                               |                | $C_{iss}$                                        | $V_{DS} = 10 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1 \text{ MHz}$                                                                                                                                                                                                                                                                                                                                  | —   | 780  | —                | pF            |
| Reverse transfer capacitance                    |                | $C_{rss}$                                        |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 90   | —                |               |
| Output capacitance                              |                | $C_{oss}$                                        |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 100  | —                |               |
| Switching time                                  | Rise time      | $t_r$                                            |  <p><math>V_{GS} = 5 \text{ V}</math><br/><math>0 \text{ V}</math><br/><math>I_D = 2.5 \text{ A}</math><br/><math>V_{OUT}</math><br/><math>4.7 \Omega</math><br/><math>4 \mu\text{H}</math><br/><math>V_{DD} \approx 10 \text{ V}</math><br/><math>\text{Duty} \leq 1\%</math>, <math>t_w = 10 \mu\text{s}</math></p> | —   | 5.0  | —                | ns            |
|                                                 | Turn-ON time   | $t_{on}$                                         |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 12   | —                |               |
|                                                 | Fall time      | $t_f$                                            |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 2.7  | —                |               |
|                                                 | Turn-OFF time  | $t_{off}$                                        |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 21   | —                |               |
| Total gate charge (gate-source plus gate-drain) |                | $Q_g$                                            | $V_{DD} \approx 16 \text{ V}$ , $V_{GS} = 5 \text{ V}$ , $I_D = 5 \text{ A}$                                                                                                                                                                                                                                                                                                                            | —   | 9.5  | —                | nC            |
| Gate-source charge 1                            |                | $Q_{gs1}$                                        |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 2.0  | —                |               |
| Gate-drain ("miller") charge                    |                | $Q_{gd}$                                         |                                                                                                                                                                                                                                                                                                                                                                                                         | —   | 2.2  | —                |               |

## Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristics         |                | Symbol    | Test Condition                                  | Min | Typ. | Max  | Unit |
|-------------------------|----------------|-----------|-------------------------------------------------|-----|------|------|------|
| Drain reverse current   | Pulse (Note 1) | $I_{DRP}$ | —                                               | —   | —    | 20   | A    |
| Forward voltage (diode) |                | $V_{DSF}$ | $I_{DR} = 5 \text{ A}$ , $V_{GS} = 0 \text{ V}$ | —   | —    | -1.2 | V    |







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